

# 2A, 600V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Switching mode converters and inverters
- Lighting application
- Snubber
- Freewheeling application

#### **MECHANICAL DATA**

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.086g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	2	Α	
$V_{RRM}$	600	V	
I <sub>FSM</sub>	35	Α	
$T_{JMAX}$	150	°C	
Package	DO-214AA (SMB)		
Configuration	Single die		









DO-214AA (SMB)



PARAMETER		SYMBOL	PU2JB	UNIT
Marking code on the device			PU2JB	
Repetitive peak reverse voltage		V <sub>RRM</sub>	600	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	420	V
Forward current		I <sub>F</sub>	2	А
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms		35	^
	t = 1.0ms	I <sub>FSM</sub>	75	A
Junction temperature	•	TJ	-55 to +150	°C
Storage temperature		T <sub>STG</sub>	-55 to +150	°C

1





THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	16	°C/W
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	68	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	16	°C/W

Thermal Performance Note: Units mounted on PCB (10mm x 10mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
	I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C		1.24	-	V
Forward voltage <sup>(1)</sup>	$I_F = 2A, T_J = 25^{\circ}C$	V	1.39	1.5	V
	I <sub>F</sub> = 1A, T <sub>J</sub> = 125°C	V <sub>F</sub>	0.98	-	V
	I <sub>F</sub> = 2A, T <sub>J</sub> = 125°C		1.14	-	V
Deverse everent @ reted V (2)	T <sub>J</sub> = 25°C	- I <sub>R</sub>	-	2	μA
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 125°C		7	-	μA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	22	-	pF
Dayoraa raaayary tima	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$	4	-	25	ns
Reverse recovery time	$I_F = 1.0A$ , di/dt = 50A/ $\mu$ s, $V_R = 30V$	t <sub>rr</sub>	26	-	
Reverse recovery current		I <sub>RM</sub>	2.4	-	Α
Reverse recovery charge	$I_F = 2.0A$ , di/dt = 200A/ $\mu$ s, $V_R = 400V$	Q <sub>rr</sub>	48	-	nC
Reverse recovery time		t <sub>rr</sub>	41	-	ns

# Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

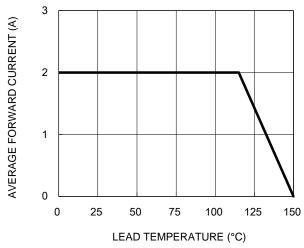
ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
PU2JB	DO-214AA (SMB)	3,000/ Tape & Reel	

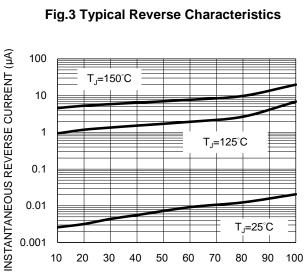


## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve





70

60

PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

90

20 30 40 50

Fig.2 Typical Junction Capacitance

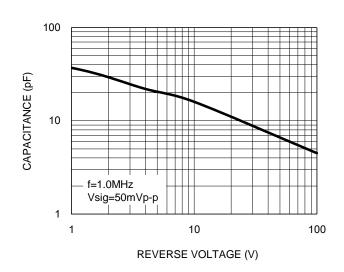


Fig.4 Typical Forward Characteristics

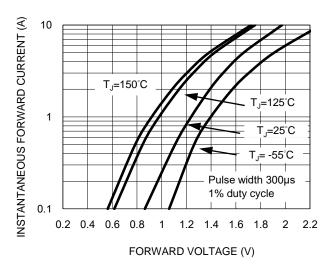
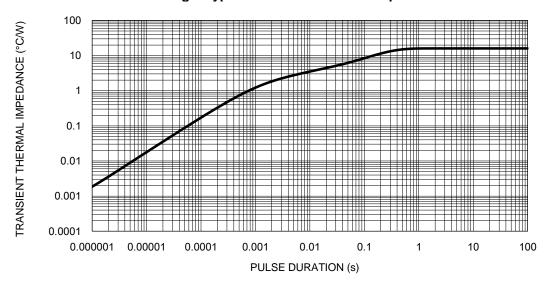


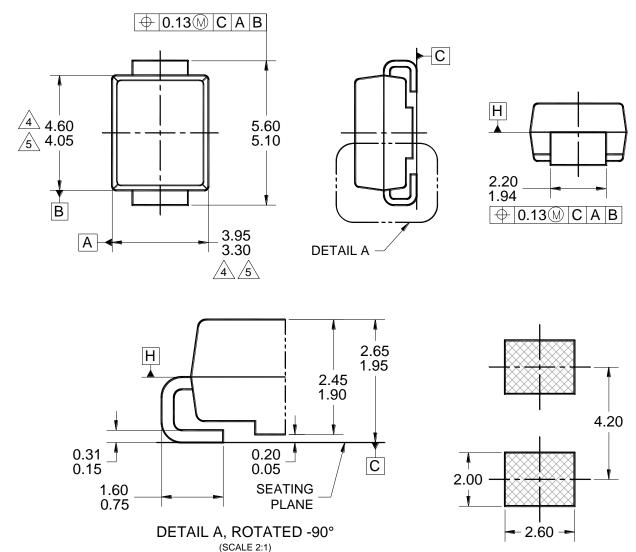
Fig.5 Typical Transient Thermal Impedance

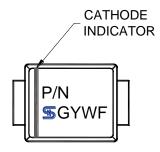




# **PACKAGE OUTLINE DIMENSIONS**

# **DO-214AA (SMB)**





#### MARKING DIAGRAM

P/N = MARKING CODE

G = GREEN COMPOUND

YW = DATE CODE

F = FACTORY CODE

#### NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AA, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.

SUGGESTED PAD LAYOUT

- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
  - 6. DWG NO. REF: HQ2SD07-DO214SMB-035 REV A.



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